#### SILICON (Si) POWER MOSFET A CEU840B



CET MOS

# **CEU840B**

# 500V 🛦 0.66Ω 🛦 7.5A 🛦 Si MOSFET

SILICON Si MOSFET ▲ SMD type N-channel enhancement mode UL94V-0 rated flame retardant epoxy TO252 (DPAK) package ▲ MSL 3 Super high dense cell density for extremely low R<sub>DS(ON)</sub> High power and current handling capability





FREE

RoHS

REACH

## **MAXIMUM RATINGS**

| Parameter (T <sub>c</sub> = 25°C, unless otherwise noted) | Characteristics                   |                 |
|---|-----------------------------------|-----------------|
| Drain-Source Voltage                                      | V <sub>DS</sub>                   | 500V            |
| Gate-Source Voltage                                       | V <sub>GS</sub>                   | ±30V            |
| Continuous Drain Current at T <sub>c</sub> = 25°C         | I <sub>D</sub>                    | 7.5A            |
| Continuous Drain Current at T <sub>c</sub> = 100°C        | I <sub>D</sub>                    | 5.3A            |
| Pulsed Drain Current Note 1                               | I <sub>DM</sub>                   | 30A             |
| Maximum Power Dissipation at $T_c = 25^{\circ}C$          | PD                                | 107W            |
| Power Dissipation Derating above 25°C                     | ΔΡ <sub>D</sub>                   | 0.71W/°C        |
| Single Pulsed Avalanche Energy Note 5                     | E <sub>AS</sub>                   | 245mJ           |
| Single Pulsed Avalanche Current Note 5                    | I <sub>AS</sub>                   | 7A              |
| Operating and Storage Temperature Range                   | T <sub>J</sub> , T <sub>STG</sub> | -55°C to +175°C |

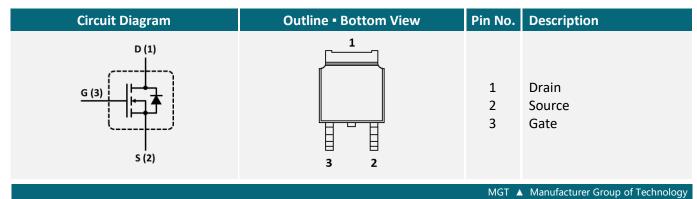
# THERMAL CHARACTERISTICS

| Parameter                               | Symbol             | Limit   |
|---|--------------------|---------|
| Thermal Resistance, Junction-to-Case    | R <sub>TH_JC</sub> | 1.4°C/W |
| Thermal Resistance, Junction-to-Ambient | R <sub>TH_JA</sub> | 50°C/W  |

#### **APPLICATIONS**

| General Lighting | Industrial | Motors   | Power    | UPS |
|------------------|------------|----------|----------|-----|
| LED & CCFL       | Inverters  | & Drives | Supplies |     |
| -Ò,-             | 0          |          |          |     |

# **PIN DESCRIPTION**



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## ELECTRICAL CHARACTERISTICS A T<sub>c</sub> = 25°C, unless otherwise noted

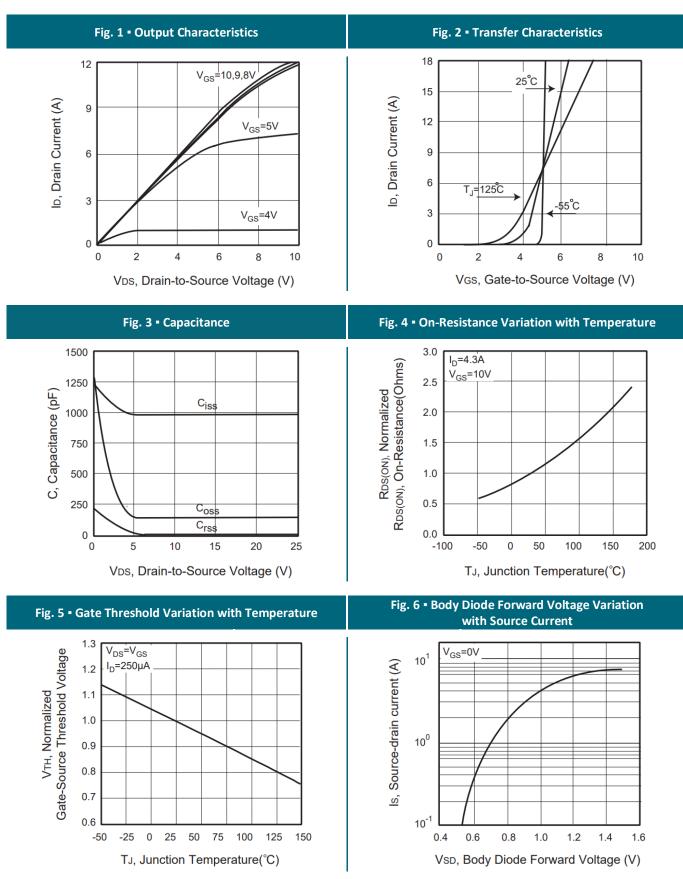
| ltem   | Condition   | Symbol              | Min. | Тур. | Max. | Unit |
|--|---|---------------------|------|------|------|------|
| Off Characteristics                          |   |                     |      |      |      |      |
| Drain-Source Breakdown Voltage               | $V_{GS} = 0V, I_D = 250\mu A$   | BV <sub>DSS</sub>   | 500  |      |      | V    |
| Zero Gate Voltage Drain Current              | $V_{DS} = 500V, V_{GS} = 0V$  | I <sub>DSS</sub>    |      |      | 1    | μA   |
| Gate Body Leakage Current, Forward           | $V_{GS} = 30V$ , $V_{DS} = 0V$  | I <sub>GSSF</sub>   |      |      | 100  | nA   |
| Gate Body Leakage Current, Reverse           | $V_{GS}$ = -30V, $V_{DS}$ = 0V  | I <sub>GSSR</sub>   |      |      | -100 | nA   |
| On Characteristics Note 3                    |   |                     |      |      |      |      |
| Gate Threshold Voltage                       | $V_{GS} = V_{DS}$ , $I_D = 250 \mu A$   | V <sub>GS(th)</sub> | 2    |      | 4    | V    |
| Static Drain-Source On-Resistance            | $V_{GS} = 10V, I_{D} = 4.3A$  | R <sub>DS(ON)</sub> |      | 0.66 | 0.8  | Ω    |
| Dynamic Characteristics Note 4               |   |                     |      |      |      |      |
| Input Capacitance                            | $V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz   | CISS                |      | 955  |      | рF   |
| Output Capacitance                           | $V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz   | Coss                |      | 140  |      | рF   |
| Reverse Transfer Capacitance                 | $V_{DS}$ = 25V, $V_{GS}$ = 0V, f = 1MHz   | C <sub>RSS</sub>    |      | 15   |      | pF   |
| Switching Characteristics Note 4             |   |                     |      |      |      |      |
| Turn-On Delay Time                           | $V_{\text{DD}}$ = 400V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 4A, $R_{\text{G}(\text{ext})}$ = 9.1 $\Omega$ | t <sub>D(ON)</sub>  |      | 25   |      | ns   |
| Turn-On Rise Time                            | $V_{\text{DD}}$ = 400V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 4A, $R_{\text{G(ext)}}$ = 9.1 $\Omega$        | t <sub>R</sub>      |      | 7    |      | ns   |
| Turn-Off Delay Time                          | $V_{\text{DD}}$ = 400V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 4A, $R_{\text{G(ext)}}$ = 9.1 $\Omega$        | t <sub>D(OFF)</sub> |      | 46   |      | ns   |
| Turn-Off Fall Time                           | $V_{\text{DD}}$ = 400V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 4A, $R_{\text{G(ext)}}$ = 9.1 $\Omega$        | t <sub>F</sub>      |      | 8    |      | ns   |
| Total Gate Charge                            | $V_{\text{DD}}$ = 400V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 7A  | Q <sub>G</sub>      |      | 22   |      | nC   |
| Gate Source Charge                           | $V_{DD}$ = 400V, $V_{GS}$ = 10V, $I_D$ = 7A   | Q <sub>GS</sub>     |      | 4    |      | nC   |
| Gate Drain Charge                            | $V_{DD}$ = 400V, $V_{GS}$ = 10V, $I_D$ = 7A   | $\mathbf{Q}_{GD}$   |      | 9    |      | nC   |
| Drain-Source Diode Characteristics a         | nd Maximum Ratings  |                     |      |      |      |      |
| Drain-Source Diode<br>Forward Current Note 2 |   | I <sub>S</sub>      |      |      | 7.5  | А    |
| Drain-Source Diode<br>Forward Voltage Note 3 | $V_{GS} = 0V$ , $I_S = 7A$  | $V_{\text{SD}}$     |      |      | 1.5  | V    |

#### Notes

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2: Surface Mounted on FR4 Board, t < 10 sec.
- Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%. 3:
- 4: Guaranteed by design, not subject to production testing.
- 5: L = 10mH,  $I_{AS}$  = 7A,  $V_{DD}$  = 60V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}$ C



# **REFERENCE DATA A TYPICAL DEVICE PERFORMANCE**



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# **REFERENCE DATA A TYPICAL DEVICE PERFORMANCE**

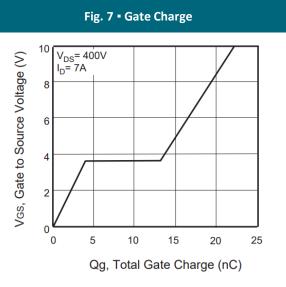
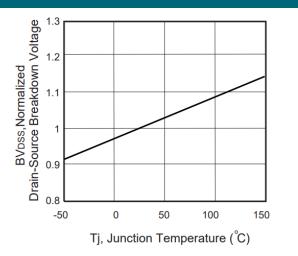
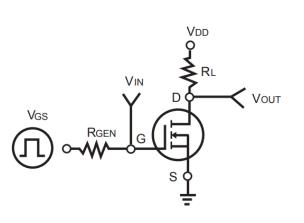


Fig. 9 - Breakdown Voltage Variation vs. Temperature







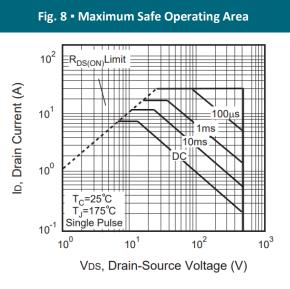
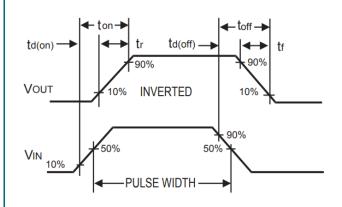


Fig. 11 • Switching Waveforms



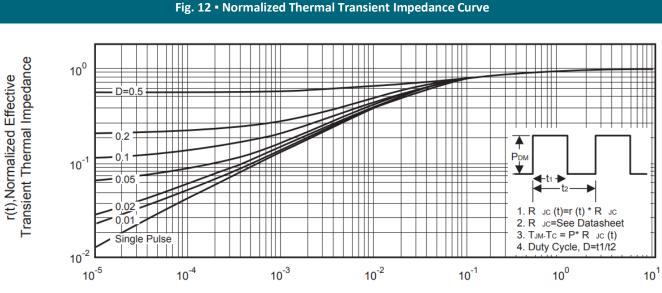
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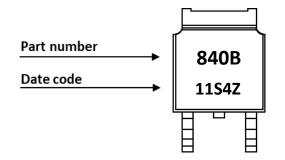


# **REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE**



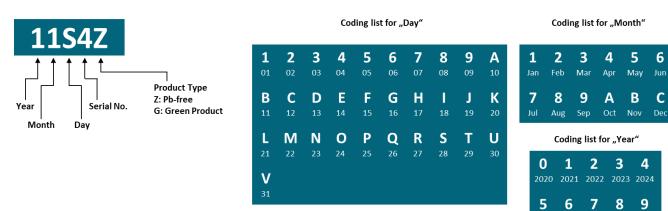
Square Wave Pulse Duration (sec)

# PART MARKING



# DATE CODE

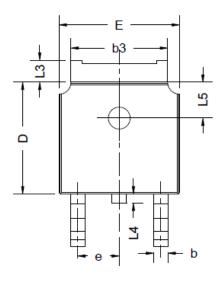
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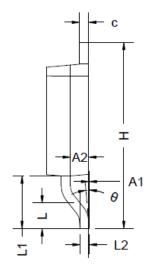


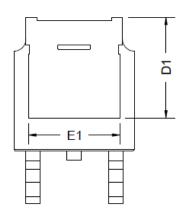
2025 2026 2027 2028 2029



# **PACKAGE OUTLINE**







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|-------|
| ۷     |
| ŧ     |

| Sym | Millimeters<br>(Min.) | Millimeters<br>(Typ.) | Millimeters<br>(Max.) | Sym | Millimeters<br>(Min.) | Millimeters<br>(Typ.) | Millimeters<br>(Max.) |
|-----|-----------------------|-----------------------|-----------------------|-----|-----------------------|-----------------------|-----------------------|
| А   | 2.20                  | 2.30                  | 2.38                  | е   |                       | 2.286 BSC             |                       |
| A1  | 0.00                  | -                     | 0.20                  | Н   | 9.40                  | 10.10                 | 10.50                 |
| A2  | 0.90                  | 1.07                  | 1.17                  | L   | 1.38                  | 1.50                  | 1.75                  |
| b   | 0.68                  | 0.78                  | 0.90                  | L1  |                       | 2.90 REF              |                       |
| b3  | 5.23                  | 5.33                  | 5.46                  | L2  |                       | 0.51 BSC              |                       |
| С   | 0.43                  | 0.53                  | 0.61                  | L3  | 0.88                  | -                     | 1.28                  |
| D   | 5.98                  | 6.10                  | 6.22                  | L4  | 0.50                  |                       | 1.00                  |
| D1  |                       | 5.30 REF              |                       | L5  | 1.65                  | 1.80                  | 1.95                  |
| E   | 6.40                  | 6.60                  | 6.73                  | θ   | 0°                    | -                     | 8°                    |
| E1  | 4.63                  | -                     | -                     |     |                       |                       |                       |

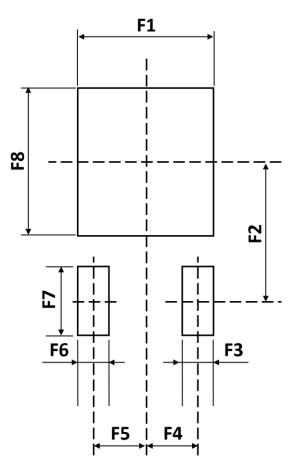
#### **ORDERING INFORMATION**

| Part Number | Package      | Packing | Reel Qty. | Inner Box Qty. | Outer Box Qty. |
|-------------|--------------|---------|-----------|----------------|----------------|
| CEU840B     | TO252 (DPAK) | Reel    | 2,500pcs  | 5,000pcs       | 40,000pcs      |

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# **RECOMMENDED PAD LAYOUT**



| Sym | Millimeters<br>(Min.) | Millimeters<br>(Typ.) | Millimeters<br>(Max.) | Sym | Millimeters<br>(Min.) | Millimeters<br>(Typ.) | Millimeters<br>(Max.) |
|-----|-----------------------|-----------------------|-----------------------|-----|-----------------------|-----------------------|-----------------------|
| F1  | -                     | 6.00                  | -                     | F5  | -                     | 2.29                  | -                     |
| F2  | -                     | 6.25                  | -                     | F6  | -                     | 1.40                  | -                     |
| F3  | -                     | 1.40                  | -                     | F7  | -                     | 3.00                  | -                     |
| F4  | -                     | 2.29                  | -                     | F8  | -                     | 6.50                  | -                     |

Notes:

1. The suggested land pattern dimensions have been provided for reference only.

2. For further information, please reference document IPC-7351A.

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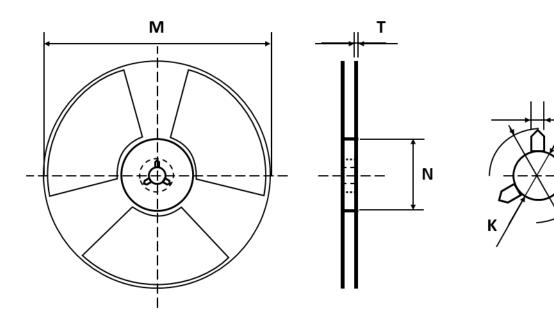


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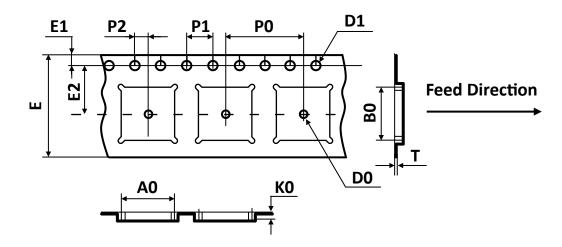


#### **REEL DIMENSIONS** All dimensions in mm



| Tape Size | Reel Size | М       | N         | Т     | Н     | К     | S     |
|-----------|-----------|---------|-----------|-------|-------|-------|-------|
|           | Ø330      | Ø330.00 | Ø100.00   | 2.10  | 22.00 | 13.00 | 2.00  |
| 16mm      |           | ±2.00   | +0 50     | +0.20 | +0 50 | +0.50 | +0.50 |
|           |           | ±2.00   | .00 ±0.50 | ±0.20 | ±0.50 | -0.20 | -0.20 |

# TAPE DIMENSIONS All dimensions in mm



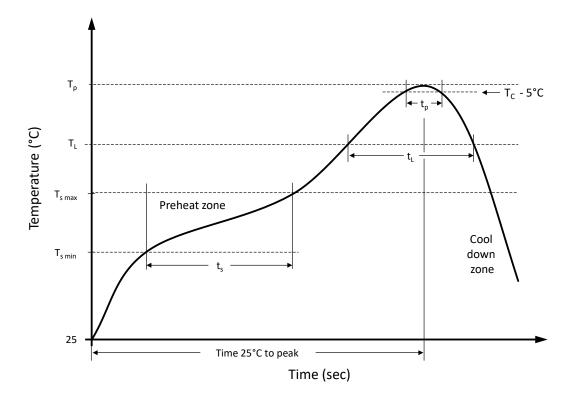
| Package | A0    | B0    | КО    | D0   | D1    | E              | E1    | E2    | P0    | P1    | P2    | т     |
|---------|-------|-------|-------|------|-------|----------------|-------|-------|-------|-------|-------|-------|
| TO252   | 6.90  | 10.50 | 2.70  | 1.50 | 1.50  | 16.00          | 1.75  | 7.50  | 8.00  | 4.00  | 2.00  | 0.30  |
| (DPAK)  | ±0.10 | ±0.10 | ±0.10 | MIN  | ±0.10 | +0.30<br>-0.20 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.05 |







#### **RECOMMENDED REFLOW SOLDERING PROFILE**



#### **Recommended reflow soldering conditions** ▲ **Refer to JEDEC J-STD-020E**

| Profile Features   |                | Sn-Pb Eutetic Assembly | Pb-Free Assembly |
|--|----------------|------------------------|------------------|
| Preheat temperature min.   | $T_{smin}$     | 100 °C                 | 150 °C           |
| Preheat temperature max.   | $T_{s max}$    | 150 °C                 | 200 °C           |
| Preheat time $t_s$ from $T_{s min}$ to $T_{s max}$                       | ts             | 120 seconds            | 120 seconds      |
| Ramp-up rate (T <sub>L</sub> to T <sub>p</sub> )                         |                | max. 3 °C/second       | max. 3 °C/second |
| Liquidous temperature  | TL             | 183 °C                 | 217 °C           |
| Time $t_L$ maintained above $T_L$  | t∟             | 150 seconds max.       | 150 seconds max. |
| Peak package body temperature  | Tp             | 235°C                  | 260°C            |
| Timeframe of within 5°C below and up to max actual peak body temperature | t <sub>p</sub> | 20 seconds max.        | 30 seconds max.  |
| Ramp-down rate ( $T_L$ to $T_p$ )  |                | max. 6 °C/second       | max. 6 °C/second |
| Time 25°C to peak temperature  |                | max. 6 minutes         | max. 8 minutes   |

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# **REVISION TABLE**

| Revision | Date       | Status          | Notes               |
|----------|------------|-----------------|---------------------|
| 001      | 30/09/2022 | Initial release | Initial publication |
|          |            |                 |                     |
|          |            |                 |                     |
|          |            |                 |                     |
|          |            |                 |                     |
|          |            |                 |                     |

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